

Pittsburgh, PA, USA - May 2018

Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Fri	Credit
Abbott, John	Corning Incorporated	Corning Incorporated	1	1	1	1		4
Abramson, David	Texas Instruments Incorporated	Texas Instruments Incorporated		1	1			2
Agnes, Andrea	STMicroelectronics	STMicroelectronics	1	1	1	1	1	5
Amason, Dale	NXP Semiconductors	NXP Semiconductors	1	1	1	1	1	5
An, Hongming	Microchip Technology, Inc.	Microchip Technology, Inc.		1	1			2
Anslow, Peter	Ciena Corporation	Ciena Corporation	1	1	1	1		4
BACA, RICHARD	Microsoft Corporation	Microsoft Corporation	1	1	1	1		4
Baggett, Tim	Microchip Technology, Inc.	Microchip Technology, Inc.	1	1	1			3
Bains, Amrik	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1		4
Balemorthy, Kasyapa		OFS	1	1	1			3
Baran, David	ARRIS Group	ARRIS Group	1	1	1			3
Baum, Andrew	Bel Stewart Connector	Bel Stewart Connector	1	1	1			3
Ben-Artzi, Liav	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.		1	1	1	1	4
Beruto, Piergiorgio	Canovatech S.r.l.	Canova Tech Srl	1	1	1	1		4
Best, Burrell	Samtec, Inc.	Samtec, Inc.		1	1	1		3
Bhatt, Vipul	Finisar Corporation	Inphi Corporation	1	1				2
bo, gao	Huawei Technologies Co. Ltd	Huawei Technologies Co., Ltd	1	1	1	1		4
Brandt, David	Rockwell Automation	Rockwell Automation	1	1				2
Braun, Ralf-Peter	Deutsche Telekom AG	Deutsche Telekom AG	1	1	1	1	1	5
Brooks, Paul	Viavi solutions GmbH	Viavi Solutions	1	1	1	1		4
Brown, Alan M	ADTRAN Inc.	ADTRAN Inc.	1	1	1			3
Brown, Matthew	MACOM	MACOM	1	1		1		3
Brownlee, Phillip	TDK Corporation	TDK Corporation	1	1	1	1	1	5
Butter, Adrian	GLOBALFOUNDRIES	GLOBALFOUNDRIES		1	1	1		3
Calvin, John	Vital Technical Marketing, Wilder Te	VTM, V-Prime, Wilder Technologies	1	1	1	1	1	5
Carlson, Craig	Cavium	Cavium				1		1
Carlson, Steven	High-Speed Design Inc.	Robert Bosch GmbH	1	1	1	1	1	5
Chabot, Craig	University of New Hampshire InterO	University of New Hampshire InterO	1	1	1	1		4
Chalupsky, David	Intel Corporation	Intel Corporation		1	1	1	1	4
Chang, Xin	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd			1	1	1	3
Chang, Yongmao	Inphi Corporation	Inphi Corporation		1	1	1		3

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Chen, Chan	Applied Optoelectronics, Inc.	Applied Optoelectronics, Inc.	1	1	1	1		4
Choudhury, Golam	OFS	OFS	1	1	1	1	1	5
Colella, Barry	Source Photonics	Source Photonics		1	1			2
Dai, Eugene	Cox Communications Inc.	Cox Communications Inc.	1	1	1	1		4
D'Ambrosia, John	Futurewei Technologies	Futurewei (Subsidiary of Huawei)	1	1		1		3
Darshan, Yair	Microsemi Corporation	Microsemi Corporation		1	1			2
Dawe, Piers J G	MellanoX Technologies	MellanoX Technologies	1	1	1	1		4
Dawson, Fred	Chemours Canada Company	Chemours Canada Company		1	1			2
den Besten, Gerrit		NXP Semiconductors		1	1	1	1	4
DeSanti, Claudio	Google	Google	1	1	1	1		4
DiBiao, Eric	TE Connectivity	TE Connectivity	1	1	1	1	1	5
Diminico, Christopher	M C Communications, LLC	Panduit Corp.	1	1	1	1		4
Donahue, Curtis	University of New Hampshire InterO	UNH-IOL	1	1	1	1	1	5
Du, Liang	Google	Google	1	1				2
Dube, Kathryn	UNH-IOL	UNH-IOL	1	1	1	1	1	5
Dudek, Michael	Cavium	Cavium	1	1	1	1		4
Dupuis, Marc	Web Industries	Web Industries	1	1	1			3
Effenberger, Frank	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1		4
Estes, David	Spirent Communications	Spirent Communications	1	1	1	1		4
Ewen, John	GLOBALFOUNDRIES	GLOBALFOUNDRIES		1	1	1		3
farjad, ramin	Aquantia	Aquantia				1	1	2
Ferretti, Vincent	Corning Incorporated	Corning Incorporated	1	1	1	1		4
Filip, Jan	Maxim Integrated Products	Maxim Integrated Products	1	1	1			3
Franchuk, Brian	Emerson Automation Solutions	Emerson Automation Solutions	1	1	1			3
Frosch, Richard	Phihong USA Inc,	Phihong USA Inc,		1	1			2
fu, shiyong	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd			1			1
Gardner, Mike	Molex Incorporated	Molex Incorporated	1	1	1	1	1	5
Gauthier, Claude	OmniPhy	NXP Semiconductors	1	1	1	1	1	5
Ghiasi, Ali	Ghiasi Quantum LLC	Ghiasi Quantum LLC, Huawei LTD	1	1	1	1		4
Gilb, James	General Atomics Aeronautical System	GA-ASI, USD, Gilb Consulting		1	1	1		3
Gong, Zhigang	O-Net Communications Ltd.	O-Net Communications Ltd.		1	1	1	1	4

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Goor, Dave	Philips Electronics	Philips Electronics	1	1	1			3
Gopalakrishnan, Karthik		Inphi Corporation				1		1
Gottron, Jens	Siemens AG	Siemens AG	1	1	1			3
Graber, Steffen	Pepperl+Fuchs GmbH	Pepperl+Fuchs GmbH		1	1	1	1	4
Grau, Olaf	Robert Bosch GmbH	Robert Bosch GmbH	1	1	1	1	1	5
Gustlin, Mark	Xilinx Inc	Xilinx		1	1	1		3
Hajduczenia, Marek	Charter Communications	Charter Communications	1	1	1	1		4
Harstead, Ed	Nokia	Nokia	1	1	1			3
Healey, Adam	Broadcom Inc.	Broadcom Inc.	1	1	1	1		4
Heck, Howard	Intel Corporation	Intel Corporation		1	1	1		3
Hegde, Rajmohan	Broadcom Corporation	Broadcom Ltd.			1	1		2
Hess, David	CORD DATA	CORD DATA		1	1	1	1	4
Holden, Brian	Kandou Bus	Kandou Bus			1	1	1	3
Horner, Rita	Synopsys, Inc.	Synopsys, Inc.				1	1	2
Hormmeyer, Bernd	Phoenix Contact	Phoenix Contact	1	1	1	1		4
Houtsma, Vincent	Nokia	Nokia	1	1	1			3
HUANG, Xi	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1		1		3
Huszak, Gergely	Self	Kone	1	1	1	1	1	5
Ingham, Jonathan	Foxconn Interconnect Technology	Foxconn Interconnect Technology	1	1	1	1		4
Isono, Hideki	FUJITSU	Fujitsu Optical Components Limited	1	1	1	1		4
Issenhuth, Tom	Issenhuth Consulting, LLC	Huawei Technologies Co. Ltd	1	1	1	1		4
Jackson, Kenneth	Sumitomo Electric Device Innovation	Sumitomo Electric Industries, LTD	1	1	1	1		4
Johnson, John	Broadcom Limited	Broadcom Limited	1	1	1	1		4
Jones, Chad	Cisco Systems, Inc.	Cisco Systems, Inc.		1	1	1		3
Jones, Peter	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1		1		3
Kao, Chienping	Intel Corporation	Intel				1	1	2
Kareti, Upen	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1		4
Kimber, Eric	Semtech Ltd	Semtech Ltd	1	1	1	1		4
King, Jonathan	Finisar Corporation	Finisar Corporation		1	1			2
Klempa, Michael	University of New Hampshire InterO	University of New Hampshire InterO	1	1		1		3
Knittle, Curtis	Cable Television Laboratories Inc. (Ca	Cable Television Laboratories Inc. (Ca	1	1	1			3

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Kochuparambil, Elizabeth	Cisco Systems, Inc.	Cisco Systems, Inc.		1	1	1		3
Kolesar, Paul	CommScope	CommScope, Inc.	1	1		1		3
Kondo, Taiji	MegaChips Corporation	MegaChips Corporation	1	1	1	1	1	5
Kramer, Glen	Broadcom Corporation	Broadcom Corporation	1	1	1	1		4
Lambrecht, Frank	Gigamon, Inc.	Gigamon, Inc.		1	1	1		3
Laubach, Mark	Broadcom Limited	Broadcom Corporation	1	1	1	1	1	5
Law, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	1	1	1	1	5
Lawlis, James	Ford Motor Company	Ford Motor Company	1	1	1	1	1	5
Le Cheminant, Greg	Keysight Technologies	Keysight Technologies	1	1	1	1		4
Lee, Han Hyub	ETRI	ETRI	1	1	1	1		4
Lemahieu, Joris	ON Semiconductor	ON Semiconductor		1				1
Lewis, David	Lumentum Inc.	Lumentum Inc.	1	1	1	1		4
Lewis, Jon	Dell EMC	Dell EMC	1	1	1	1	1	5
Li, Weishi		Huawei Technologies Co., Ltd	1	1	1	1		4
Lim, Jane	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1		4
lin, bin		TE Connectivity	1	1	1	1	1	5
Lingle, Robert	OFS	OFS	1	1	1			3
Liu, Hai-Feng	Intel	Intel Corporation	1	1	1	1		4
Liu, Karen	Kaiam Corp	Kaiam Corporation			1	1		2
Lukacs, Miklos	Silicon Laboratories	Silicon Laboratories	1	1	1			3
Lusted, Kent	Intel Corporation	Intel Corporation	1	1	1	1	1	5
Maguire, Valerie	The Siemon Company	The Siemon Company	1	1	1	1		4
Maki, Jeffery	Juniper Networks, Inc.	Juniper Networks, Inc.	1	1	1	1	1	5
Malicoat, David	Malicoat Networking Solutions	Aquantia; SENKO Advanced Compon	1	1	1	1	1	5
Marris, Arthur	Cadence Design Systems, Inc.	Cadence Design Systems, Inc.	1	1	1	1	1	5
MASUDA, TAKEO	OITDA	OITDA	1	1	1	1	1	5
Matheus, Kirsten	BMW Group	BMW Group	1	1	1	1		4
Matoglu, Erdem	Amphenol Corporation	Amphenol Corporation		1	1	1		3
Mazzini, Marco	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1		4
McCarthy, Mick	Analog Devices Inc.	Analog Devices Inc.	1	1	1	1		4
Mcclellan, Brett	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1	1	1	5

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Meachen, Jacob	Semtech EMEA	Semtech Ltd	1	1				2
Medina, Marcel	Spirent Communications	Spirent Communications	1	1	1	1		4
Mellitz, Richard	Samtec, Inc.	Samtec, Inc.		1	1	1	1	4
Migueluez, Phil	Comcast	Comcast	1	1	1			3
Moritake, Toshiyuki	Japan Aviation Electronics Ind., LTD.	Japan Aviation Electronics Ind., LTD.	1	1	1			3
Mueller, Harald	Endress + Hauser	Endress + Hauser	1	1	1			3
Mueller, Thomas	Rosenberger	Rosenberger				1	1	2
Murty, Ramana		Broadcom Corporation		1				1
Neveux, Paul	Superior Essex	Superior Essex	1	1	1	1		4
Nicholl, Gary	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1		4
Nolan, John	QLogic Corporation	QLogic Corporation		1	1	1	1	4
Noll, Kevin	TiBiT Communications	Tibit Communications	1	1	1			3
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.	1					1
Ofelt, David	Juniper Networks, Inc.	Juniper Networks, Inc.	1	1	1	1		4
Ohni, Josef	MD Elektronik GmbH	MD Elektronik				1	1	2
Pachon, Arturo	TE Connectivity	TE Connectivity		1	1	1	1	4
Palkert, Thomas	EIC	Molex-Macom	1	1	1	1		4
Pandey, Sujan	NXP Semiconductors	NXP Semiconductors	1	1	1	1	1	5
Parsons, Earl	CommScope, Inc.	CommScope, Inc.	1	1	1			3
Parthasarathy, Vasu	Broadcom Corporation	Broadcom Corporation	1	1				2
Patel, Harsh	Molex LLC	Molex LLC				1	1	2
Pham, Phong	US Conec, Ltd.	US Conec, Ltd.	1	1	1	1	1	5
Piehler, David	Dell	Dell EMC	1	1	1	1		4
Pimpinella, Rick	Panduit Corp.	Panduit Corp.	1	1	1	1		4
Powell, William	Nokia	Nokia	1	1	1			3
Pozzebon, Dino	Microsemi Corporation	Microsemi Corporation			1	1	1	3
Rabinovich, Rick	Keysight Technologies	Keysight Technologies	1	1	1	1		4
Ran, Adee	Intel Corporation	Intel Corporation		1		1	1	3
Regev, Alon	Keysight Technologies	Keysight Technologies	1	1	1	1		4
Remein, Duane	Futurewei Technologies	Huawei Technologies Co. Ltd	1	1	1	1		4
Renteria, Victor	Bel Fuse	Bel Fuse	1	1	1			3

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Rotolo, Salvatore	STMicroelectronics	STMicroelectronics	1	1	1	1		4
Ryan, Tim	UNH-IOL	UNH-IOL	1	1	1	1		4
Rysin, Alexander	Mellanox Technologies	Mellanox Technologies		1	1	1		3
Sakai, Toshiaki	Socionext	socionext	1	1	1	1		4
Sarlet, Gert	Finisar Corporation	Finisar Corporation	1					1
Sayre, Edward	Samtec, Inc.	Teraspeed, a division of Samtec	1	1	1	1		4
Scantamburlo, Nicola	Canova Tech	Canova Tech	1	1	1	1		4
Schmitt, Matthew	Cable Television Laboratories Inc. (Ca	Cable Television Laboratories Inc. (Ca	1					1
Sekel, Steve	Keysight Technologies	Keysight Technologies	1	1	1	1		4
Shariff, Masood	CommScope, Inc.	CommScope, Inc.	1	1	1	1	1	5
Shigematsu, Masayuki	Innovation Core SEI	Innovation Core SEI				1	1	2
Shrikhande, Kapil	Innovium Inc.	Innovium				1		1
Slavick, Jeff	Broadcom Limited	Broadcom Limited		1	1	1		3
Smith, Daniel	Seagate Technology LLC	Seagate Technology LLC				1		1
Sommers, Scott	Molex Incorporated	Molex Incorporated	1	1	1	1	1	5
Sostawa, Bernd		Microchip Technology Germany II Gr	1	1	1			3
Souvignier, Tom	Broadcom Corporation	Broadcom Corporation				1	1	2
Sparrowhawk, Bryan	Leviton Manufacturing Co.	Leviton Manufacturing Co.	1	1	1	1		4
Stassar, Peter	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1		4
Stewart, Heath	Analog Devices Inc.	Analog Devices Inc.	1	1	1	1		4
Stone, Robert	Broadcom Corporation	Broadcom Corporation			1	1		2
Stover, David	Analog Devices Inc.	Analog Devices Inc.	1	1	1			3
Sun, Junqing	Credo Semiconductor	Credo Semiconductor	1	1	1	1	1	5
Swanson, Steven	Corning Incorporated	Corning Incorporated	1	1	1			3
TAKAHARA, TOMOO	FUJITSU LABORATORIES LIMITED	FUJITSU LABORATORIES LIMITED	1	1	1	1		4
Tamura, Kohichi	Oclaro Japan Inc.	Oclaro Japan Inc.		1	1	1		3
TAZEBAY, MEHMET	Broadcom Corporation	Broadcom Corporation	1	1	1	1		4
Thompson, Geoffrey	GraCaSI S.A.	INDEPENDENT		1	1	1	1	4
Tooyserkani, Pirooz	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1		4
Tracy, Nathan	TE Connectivity	TE Connectivity	1	1	1	1	1	5
Tremblay, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise		1	1			2

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Trowbridge, Stephen	Nokia	Nokia	1	1	1	1		4
Tu, Mike	Broadcom Corporation	Broadcom Corporation				1	1	2
Twombly, Jeff	Credo Semiconductor	Credo Semiconductor		1	1	1		3
Ulrichs, Ed	Source Photonics	Source Photonics	1	1	1	1		4
Umnov, Alexander	Corning Incorporated	Corning Incorporated	1	1	1			3
Vanderlaan, Paul	Berk-Tek LLC	Berk-Tek LLC	1	1	1	1	1	5
Vernickel, Ricky	LEONI	LEONI				1	1	2
Vitali, Marco	Sicoya	Sicoya	1	1	1	1		4
Voss, Robert	Panduit Corp.	Panduit Corp.	1	1	1	1		4
Walker, Dylan	Cisco Systems, Inc.	Cisco Systems, Inc.		1	1			2
Walter, Edward	AT&T	AT&T	1	1	1	1		4
wang, haifei	Huawei Technologies Co. Ltd	Huawei Technologies Co., Ltd	1	1	1	1		4
Wang, Min		Waymo				1	1	2
Wang, Xinyuan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1		4
Wechsler, Christoph	Audi AG	Audi AG	1	1		1	1	4
Welch, Brian	Luxtera	Luxtera		1	1	1		3
white, martin	Cavium	Cavium				1		1
Wienckowski, Natalie	General Motors Company	General Motors Company			1	1	1	3
Williams, Tom	Acacia Communications	Acacia Communications	1					1
Willis, Paul	UNH-IOL	UNH-IOL	1	1	1	1		4
Withey, James	Fluke Corporation	Fluke Corporation	1	1		1	1	4
Wu, Peter	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1	1	1	5
Wucher, Markus	Endress + Hauser Flowtec AG	Endress + Hauser	1	1	1			3
XU, LI	Huawei Technologies Co. Ltd	HUAWEI	1	1	1	1	1	5
Xu, Yu	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1		4
Yamamoto, Shuto	Nippon Telegraph and Telephone Co	Nippon Telegraph and Telephone Co	1	1	1	1	1	5
Young, Adrian	Leviton Manufacturing Co.	Leviton Manufacturing Co.	1	1	1	1		4
Young, James	CommScope, Inc.	CommScope	1	1	1			3
Yseboodt, Lennart	Signify	Philips Electronics	1	1	1			3
Zambell, Andrew	Amphenol Corporation	Amphenol-FCI		1	1	1		3
Zerna, Conrad	Fraunhofer IIS	Fraunhofer IIS	1	1	1	1	1	5

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Zhang, Geoffrey	Xilinx	Xilinx				1		1
Zhou, Richard (Yujia)	Charter Communications	Charter Communications	1	1	1	1		4
Zhuang, Yan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1		4
Zielinski, Martin	Emerson Electric Co.	Emerson Process Management	1	1	1			3
Zimmerman, George	CME Consulting	ADI, APL Group, Aquantia, BMW, Co	1	1	1	1	1	5
Zivny, Pavel	Tektronix, Inc.	Tektronix, Inc.	1	1	1	1	1	5